

PE601CA

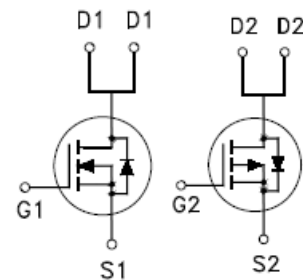
N&P-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D	Channel
30V	22m Ω @ $V_{GS} = 10V$	20A	N
-30V	28m Ω @ $V_{GS} = -10V$	-19A	P



100% UIS Tested
PDFN 3X3P 100% Rg Tested



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	CH.	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	N	30	V
			P	-30	
Gate-Source Voltage		V_{GS}	N	± 20	V
			P	± 20	
Continuous Drain Current ⁴	$T_C = 25\text{ }^{\circ}\text{C}$	I_D	N	20	A
	$T_C = 100\text{ }^{\circ}\text{C}$		P	-19	
	$T_A = 25\text{ }^{\circ}\text{C}$		N	13	
	$T_A = 70\text{ }^{\circ}\text{C}$		P	-12	
			N	8.1	
			P	-7.4	
			N	6.5	
			P	-5.9	
Pulsed Drain Current ¹		I_{DM}	N	40	
			P	-35	
Avalanche Current		I_{AS}	N	11.9	
			P	-19.3	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	N	7.1	mJ
			P	18.7	
Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	P_D	N	17	W
			P	18	
	$T_C = 100\text{ }^{\circ}\text{C}$		N	7.1	
			P	7.3	

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Power Dissipation ³	T _A = 25 °C	P _D	N	2.7	W
	T _A = 70 °C		P	2.7	
			N	1.7	
			P	1.7	
Junction & Storage Temperature Range		T _J , T _{stg}		-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	CH.	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$t \leq 10\text{s}$	$R_{\theta JA}$	N		45	$^{\circ}\text{C} / \text{W}$
			P		45	
Junction-to-Ambient ²	Steady-State		N		71	
			P		69	
Junction-to-Case	Steady-State	$R_{\theta JC}$	N		7	
			P		6.8	

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}\text{C}$.

³The Power dissipation is based on $R_{\theta JA}$ $t \leq 10\text{s}$ value.

⁴Package limitation current is N-Ch=8.3A, P-Ch=-6.9A.

ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	CH.	LIMITS			UNITS
				MIN	TYP	MAX	
STATIC							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	N	30			V
		$V_{GS} = 0V, I_D = -250\mu A$	P	-30			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	N	1	1.6	2.5	
		$V_{DS} = V_{GS}, I_D = -250\mu A$	P	-1	-1.5	-2.5	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	N			± 100	nA
		$V_{DS} = 0V, V_{GS} = \pm 20V$	P			± 100	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$	N			1	μA
		$V_{DS} = -24V, V_{GS} = 0V$	P			-1	
		$V_{DS} = 20V, V_{GS} = 0V, T_J = 55\text{ }^{\circ}C$	N			10	
		$V_{DS} = -20V, V_{GS} = 0V, T_J = 55\text{ }^{\circ}C$	P			-10	

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Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 6A	N		17.1	32	mΩ
		V _{GS} = -4.5V, I _D = -5A	P		28.2	45	
		V _{GS} = 10V, I _D = 7A	N		12.6	22	
		V _{GS} = -10V , I _D = -6A	P		20.2	28	
Forward Transconductance ¹	g _{fs}	V _{DS} = 10V, I _D = 7A	N		40		S
		V _{DS} = -10V, I _D = -6A	P		17.5		
DYNAMIC							
Input Capacitance	C _{iss}	N-Channel V _{GS} = 0V, V _{DS} = 15V, f = 1MHz P-Channel V _{GS} = 0V, V _{DS} = -15V, f = 1MHz	N		344		pF
Output Capacitance	C _{oss}		P		904		
			N		72		
Reverse Transfer Capacitance	C _{rss}		P		143		
			N		50		
			P		123		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz	N		2.8		Ω
			P		11.3		
Total Gate Charge ²	Q _g	N-Channel V _{DS} = 15V , I _D = 10A I _D = 7A P-Channel V _{DS} = -15V , V _{GS} = -10V, I _D = -6A	N		7.8		nC
Gate-Source Charge ²	Q _{gs}		P		21		
			N		1		
Gate-Drain Charge ²	Q _{gd}		P		2		
			N		2		
			P		6.1		
Turn-On Delay Time ²	t _{d(on)}	N-Channel V _{DS} = 15V, I _D ≅ 7A, V _{GS} = 10V, R _{GEN} = 6Ω P-Channel V _{DS} = -15V, ID ≅ -6A, VGS = -10V, R _{GEN} = 6Ω	N		15		nS
Rise Time ²	t _r		P		15		
			N		30		
Turn-Off Delay Time ²	t _{d(off)}		P		30		
			N		20		
Fall Time ²	t _f		P		50		
			N		13		
			P		41		

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SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_j = 25 °C)

Continuous Current ³	I _S		N			15	A
			P			-18	
Forward Voltage ¹	V _{SD}	I _F = 7A, V _{GS} = 0V	N			1.1	V
		I _F = -6A, V _{GS} = 0V	P			-1	
Reverse Recovery Time	t _{rr}	I _F = 7A, dI _F /dt = 100A / μS I _F = -6A, dI _F /dt = 100A / μS	N		8.6		nS
			P		12.2		
Reverse Recovery Charge	Q _{rr}		N		2.1		nC
			P		3.7		

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

²Independent of operating temperature.

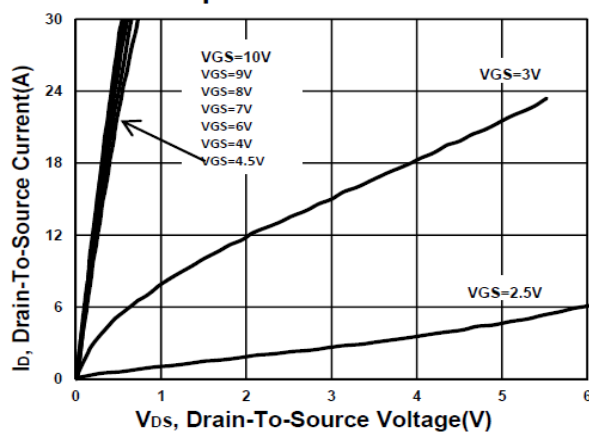
³Package limitation current is N-Ch=8.3A, P-Ch=-6.9A.

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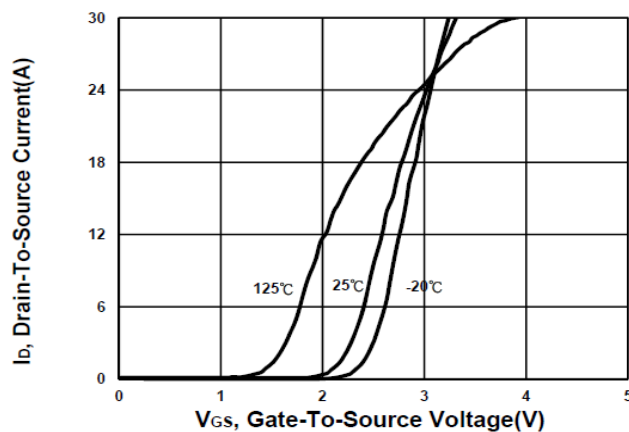
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N-CHANNEL

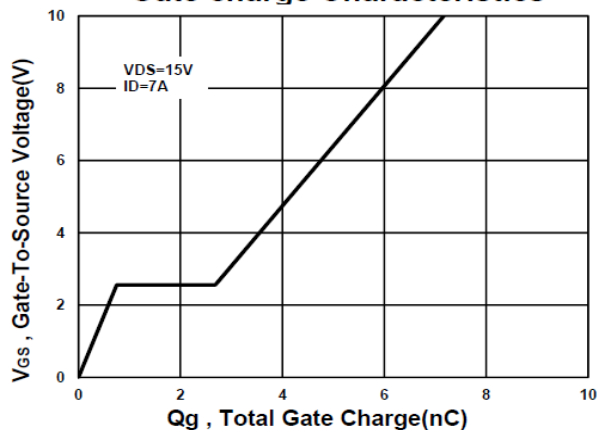
Output Characteristics



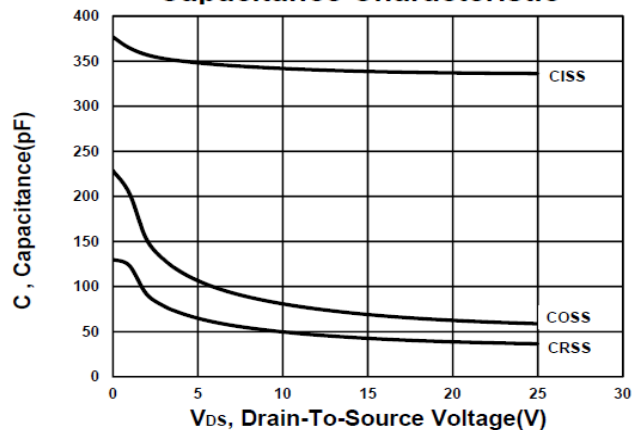
Transfer Characteristics



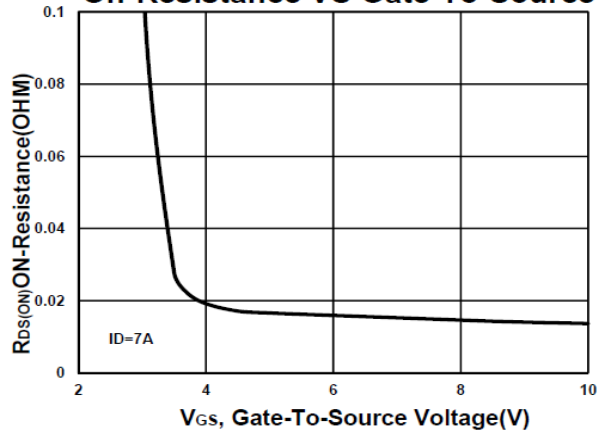
Gate charge Characteristics



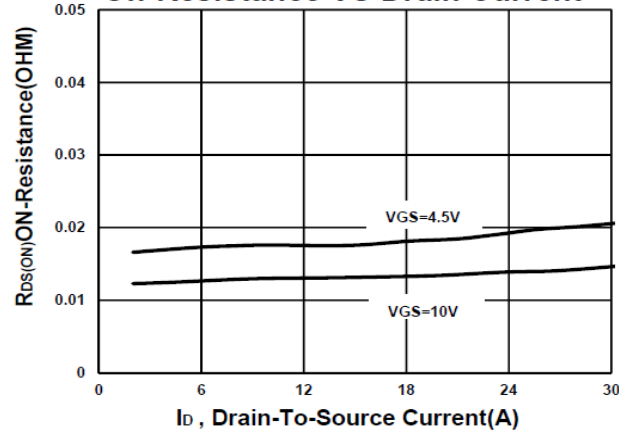
Capacitance Characteristic



On-Resistance VS Gate-To-Source



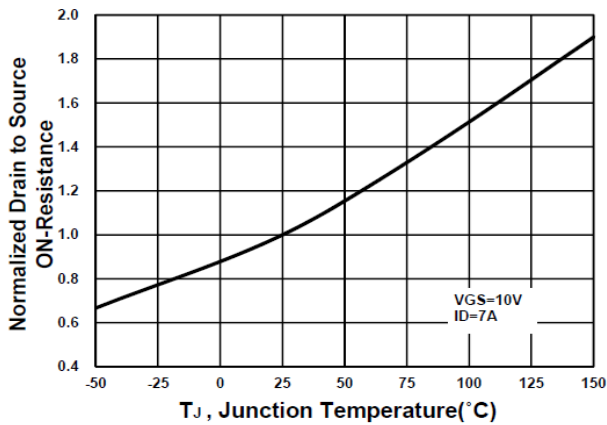
On-Resistance VS Drain Current



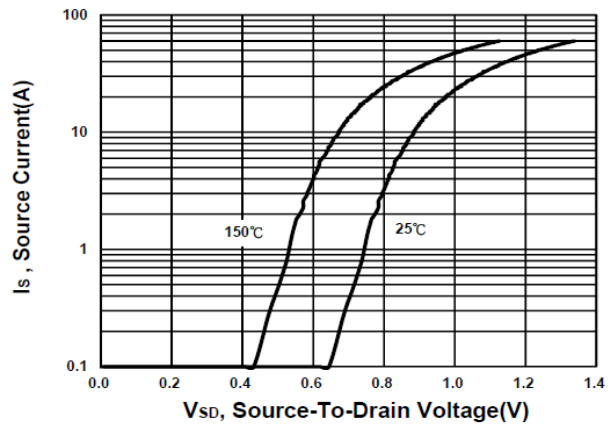
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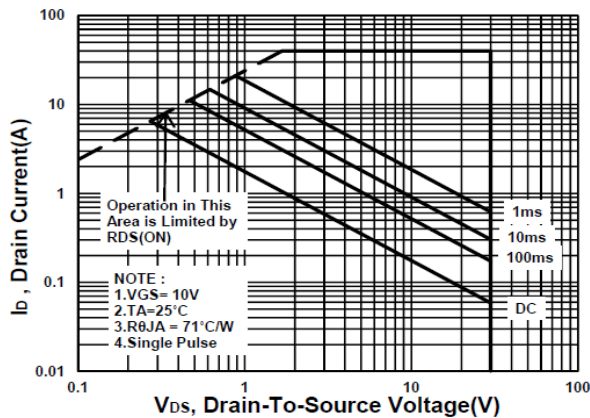
On-Resistance VS Temperature



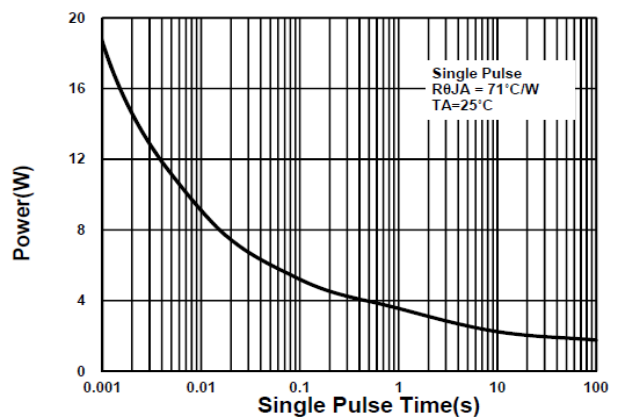
Source-Drain Diode Forward Voltage



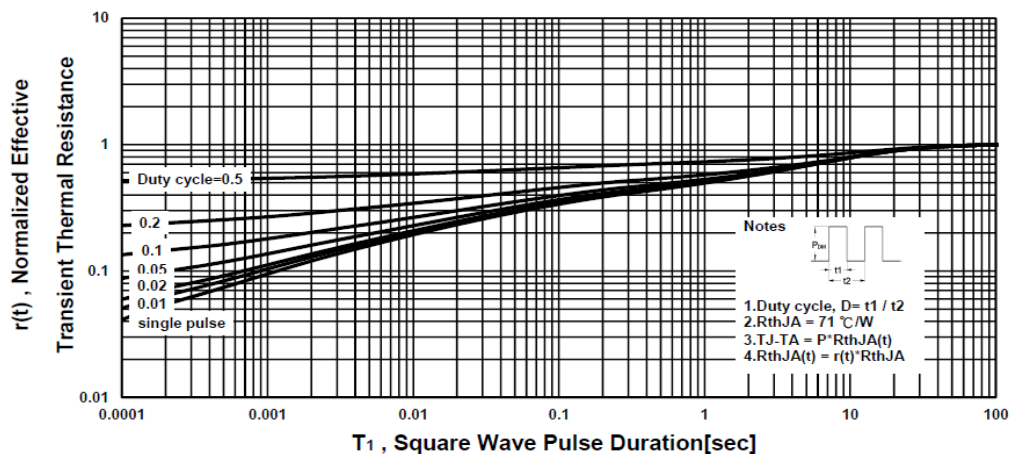
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

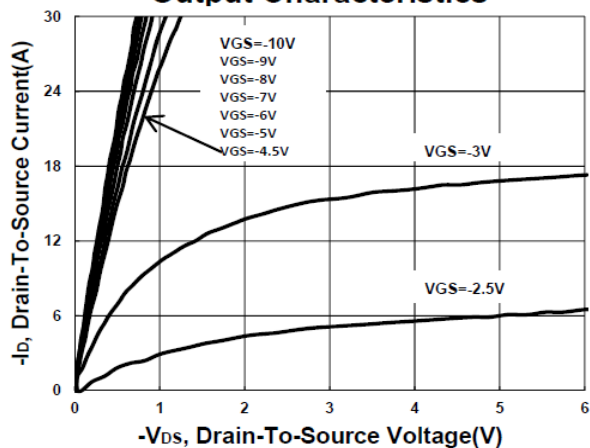


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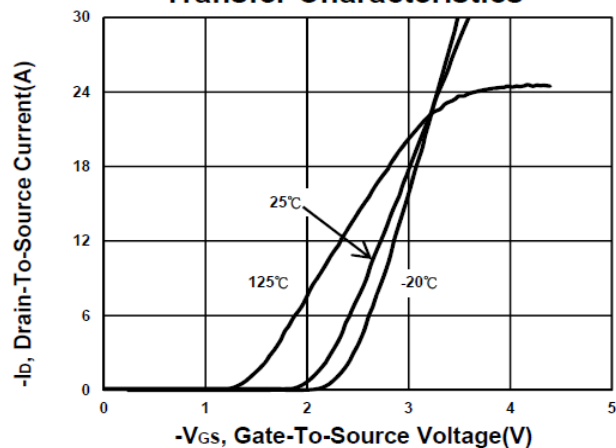
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P-CHANNEL

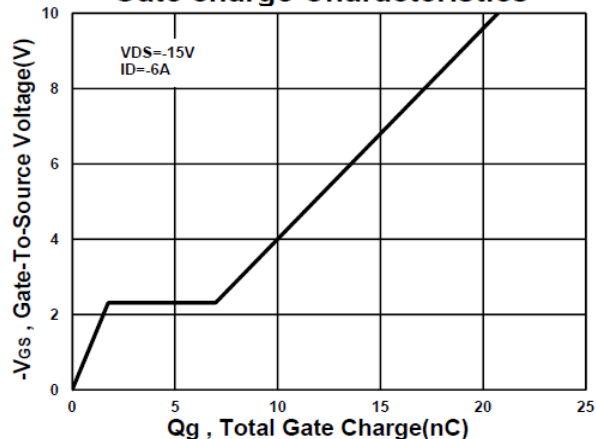
Output Characteristics



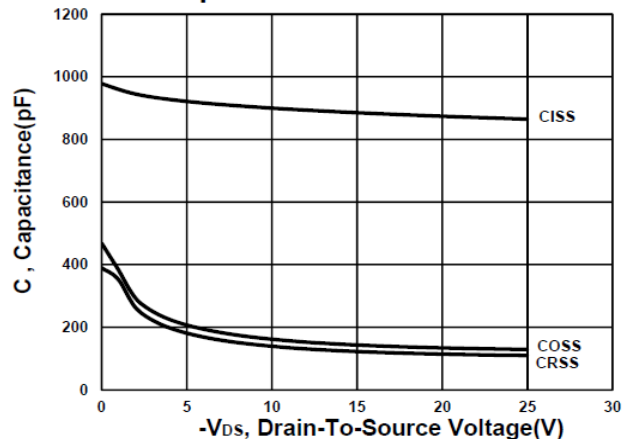
Transfer Characteristics



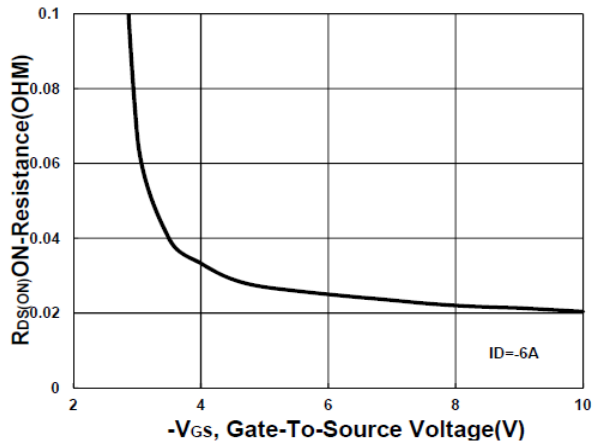
Gate charge Characteristics



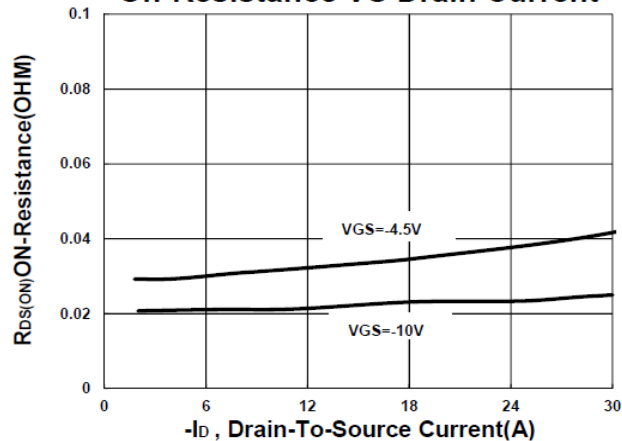
Capacitance Characteristic



On-Resistance VS Gate-To-Source



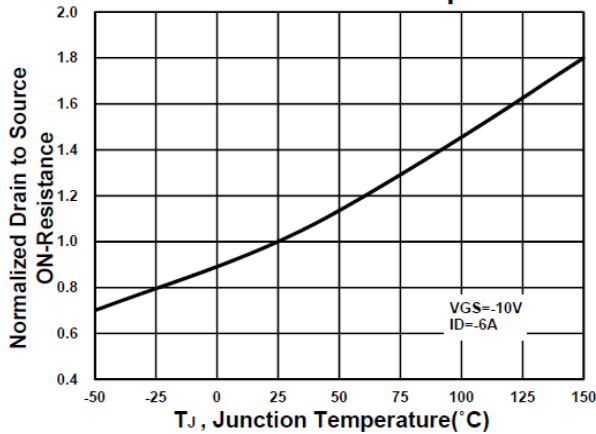
On-Resistance VS Drain Current



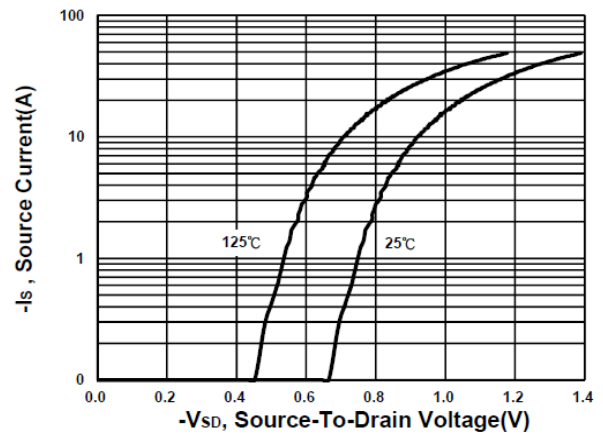
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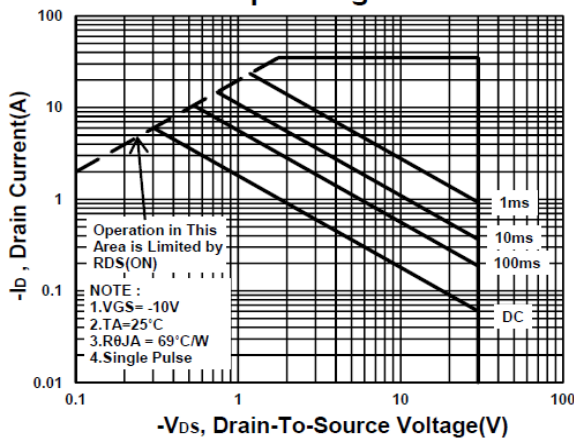
On-Resistance VS Temperature



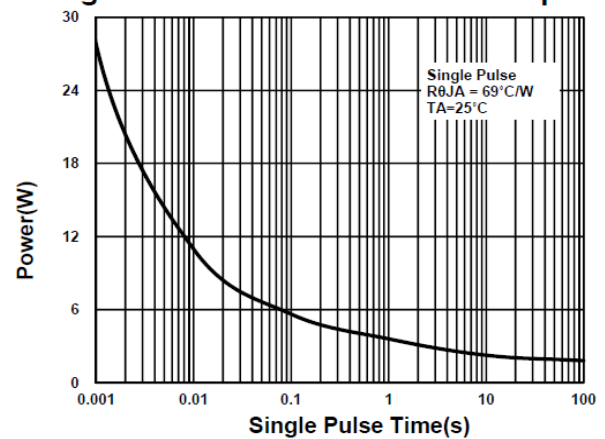
Source-Drain Diode Forward Voltage



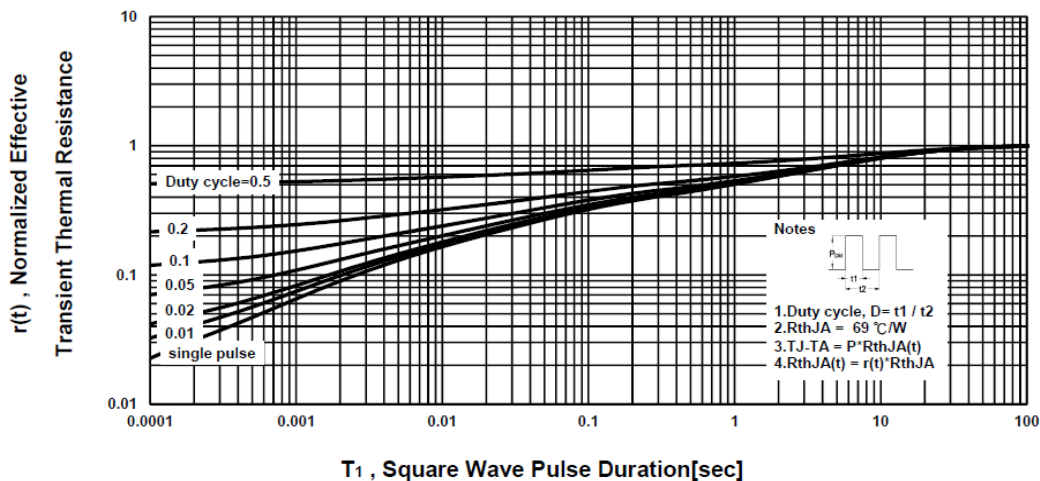
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



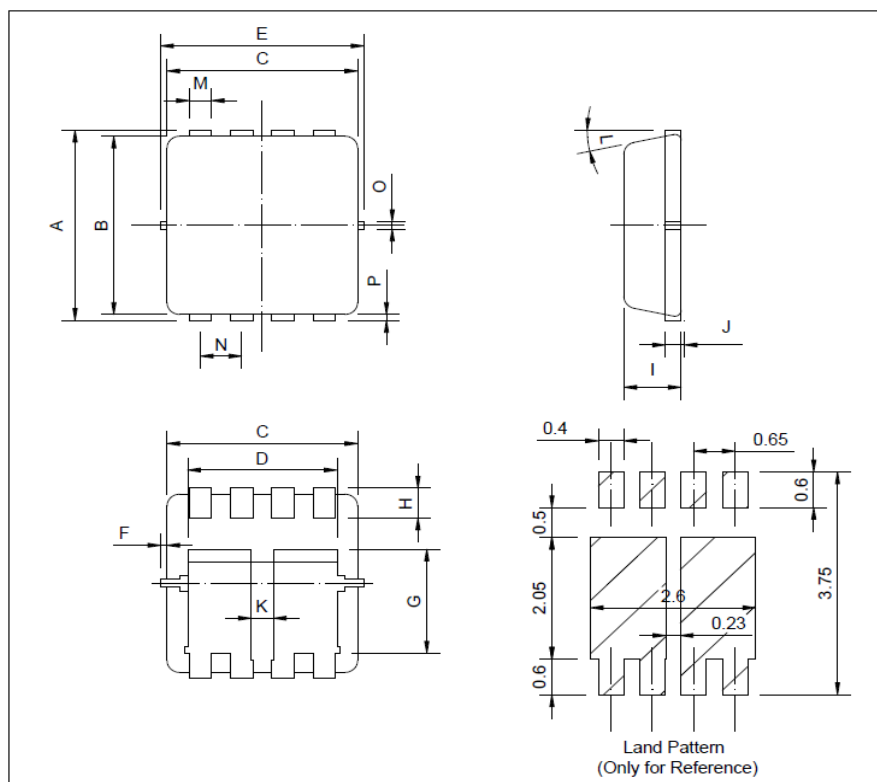
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Package Dimension

PDFN 3x3P(Dual) MECHANICAL DATA

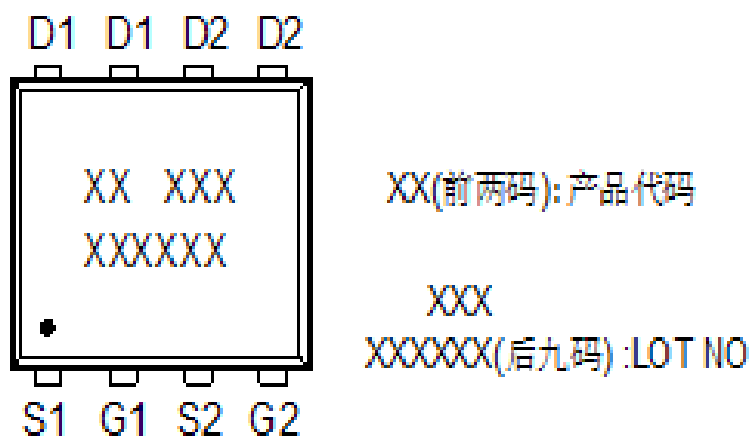
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	3.2	3.3	3.4	I	0.7	0.75	0.8
B	2.95	3.05	3.15	J	0.1	0.15	0.25
C	2.95	3.05	3.15	K	0.35		
D		2.29		L	0°	10°	12°
E	3.2	3.3	3.4	M	0.27	0.32	0.37
F		0.13		N		0.65	
G	1.7	1.83	1.96	O		0.2	
H	0.3	0.4	0.5	P	0.06	0.13	0.2



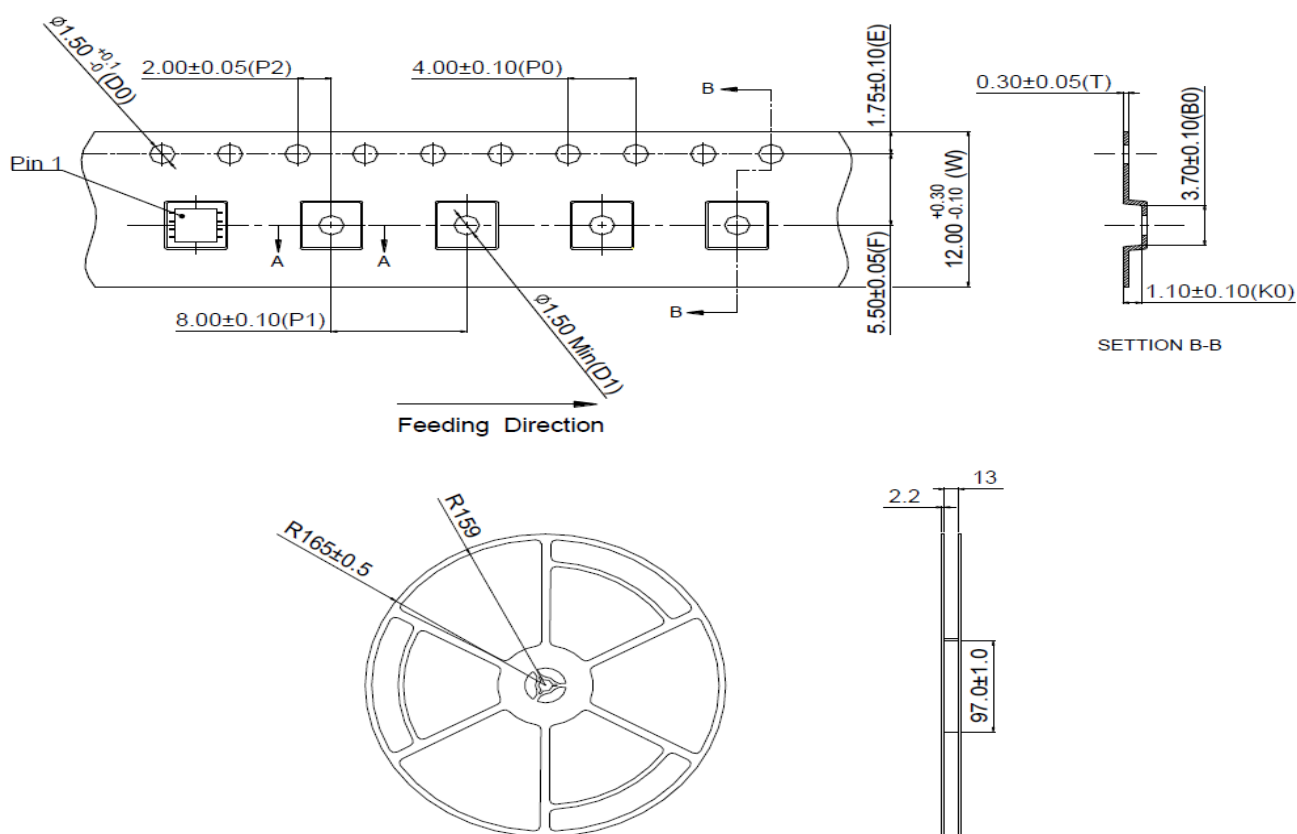
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A. Marking Information(此产品代码为: K9)



B. Tape & Reel Information: 5000pcs/Reel



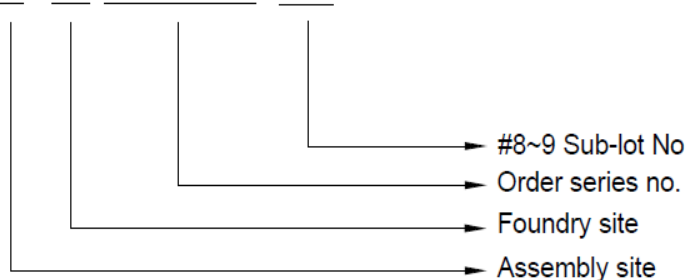
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C. Lot.No. & Date Code rule

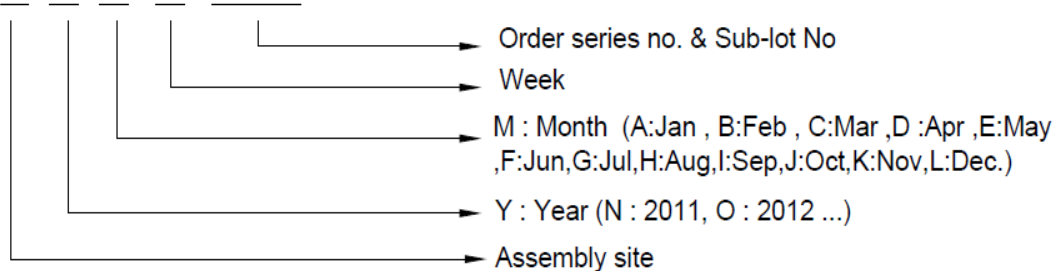
1.LOT.NO.

M N 15M21 03



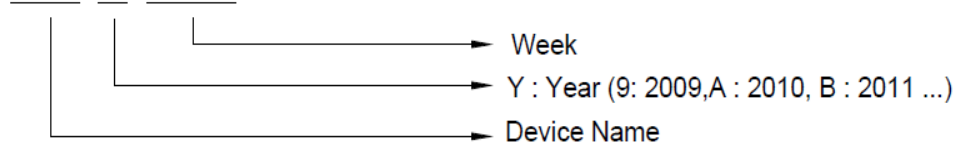
2.Date Code

D Y M X XXX



3.Date Code (for Small package)

XX Y WW



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D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm
2	Font style	Times New Roman or Arial (或可区分英文"0"和数字"0", "G"和"Q"的字型即可)
3	Great Power	Height: 4 mm
4	Package	Height: 2 mm
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12
6	Device	Height: 3 mm (Max: 16 Digit)
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot
8	D/C	Height: 3 mm (Max: 7 Digit)
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed
10	Pb Free label	 Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
11	Halogen Free label	 Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
12	Scan info	Device / Lot / D/C / QTY , Insert " / " between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least